

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JERRY ZHIJUN ZHAI	12/23/2015
RECEIVING PARTY DATA	
Name:	SUZHOU QING XIN FANG ELECTRONICS TECHNOLOGY CO., LTD.
Street Address:	UNIT 208, CN-23
Internal Address:	99 JINJI LAKE AVENUE
City:	SUZHOU
State/Country:	CHINA
Postal Code:	215123
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14956655
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ATTORNEY DOCKET NUMBER:	JZZ14-01
NAME OF SUBMITTER:	RICHARD E. GAMACHE
SIGNATURE:	/Richard E. Gamache/
DATE SIGNED:	01/04/2016
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, I, Jerry Zhijun Zhai, have invented a certain improvement in **METHODS AND DEVICES OF LAMINATED INTEGRATIONS OF SEMICONDUCTOR CHIPS, MAGNETICS, AND CAPACITANCE** described in an application for Letters Patent of the United States, the specification of which was filed in the United States Patent and Trademark Office on December 2, 2015, as Application No. 14/956,655; and

WHEREAS, Suzhou Qing Xin Fang Electronics Technology Co., Ltd. (hereinafter "ASSIGNEE"), a corporation organized under the laws of China and having a usual place of business at Unit 208, CN-23, 99 Jinji Lake Avenue, Suzhou, China 215123, desires to acquire an interest therein in accordance with agreements duly entered into with me;

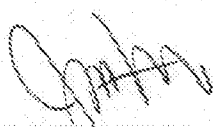
NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to any and all inventions as described in said application, and all non-provisional, divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent that claim benefit of the priority of said application and which have been or are subsequently filed in the United States and all foreign countries on any of said inventions; and in and to all original and reissued patents which have been or are subsequently issued in the United States and all foreign countries on said inventions including the right to apply for patent right in each foreign country and all rights to priority, and further including the right to sue for past infringement. I hereby convey all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said inventions, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

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AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid inventions to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of non-provisional, divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent, and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said inventions or any application or patent directed thereto may be involved;

AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based on said application to said ASSIGNEE, its successors, assigns and legal representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and affixed my seal on the date set forth below.

Inventor: 
Jerry Zhijun Zhai

DEC. 23, 2015
Date

Witness: Backham Bin Wu
Signature

DEC. 24, 2015
Date

Backham Bin Wu
Printed Name